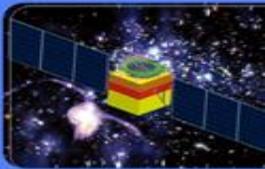


The Status of the HCAL

2025-04-29

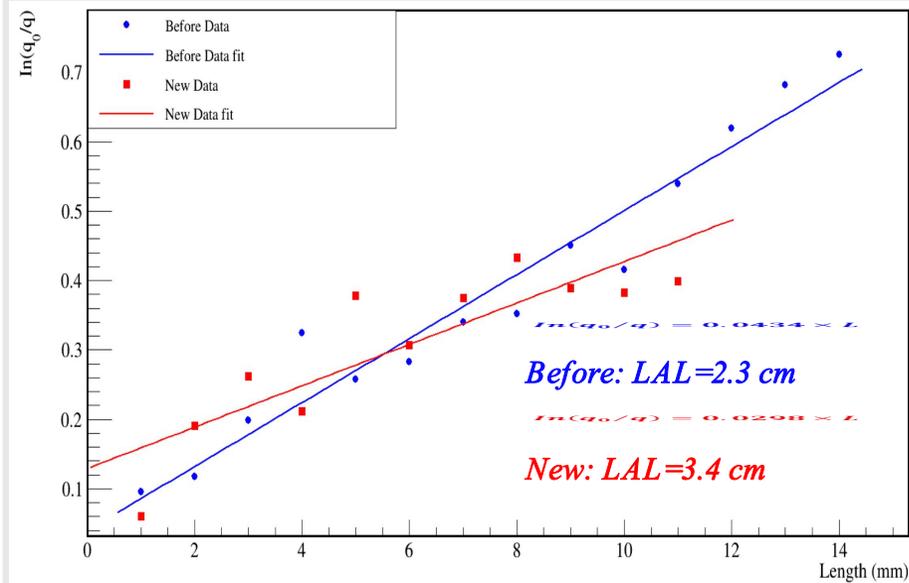
WWW.IHEP.CAS.CN



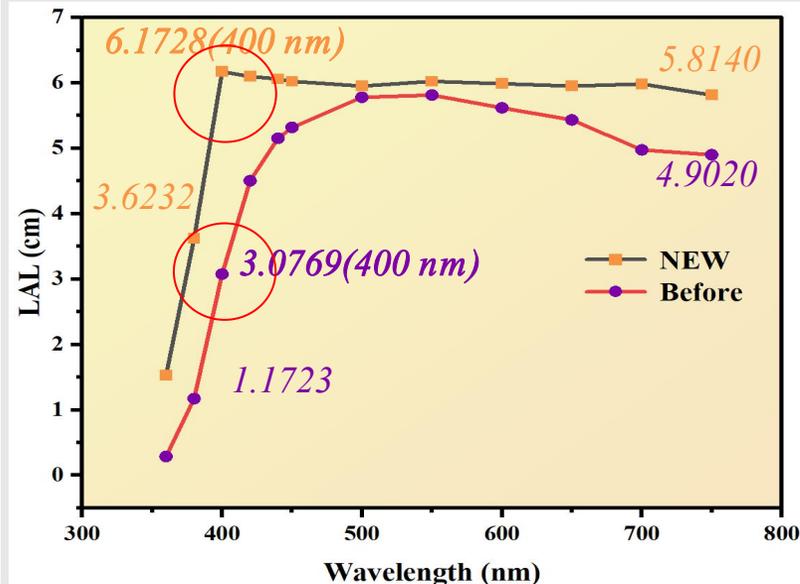
Qian Sen, on behalf of the HCAL Group
qians@ihep.ac.cn

Current status of the GS-HCAL Glass Scintillator

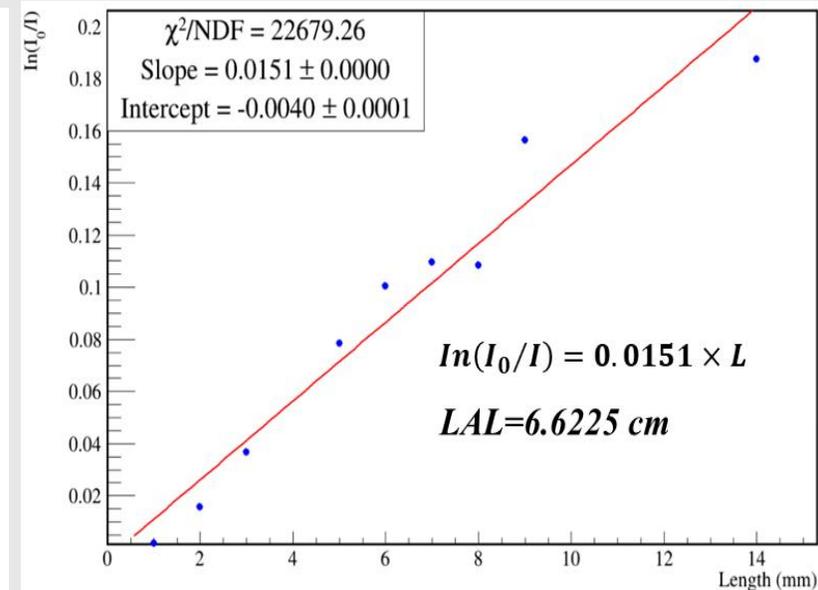
Light attenuation length Calculated by LY, transmittance and light intensity



Calculated by LY



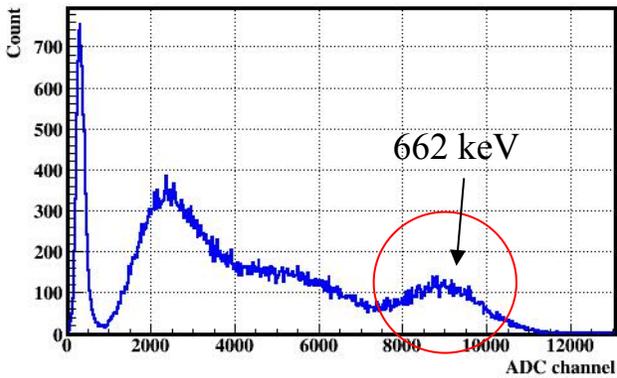
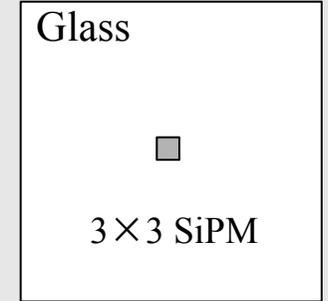
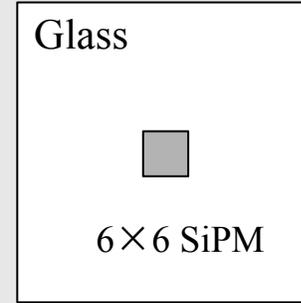
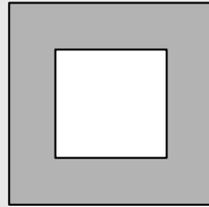
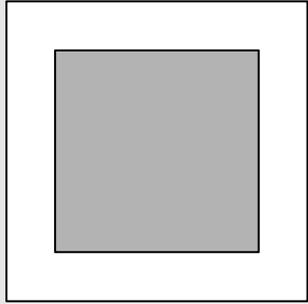
Calculated by transmittance



Calculated by light intensity

- The new LAL calculated by LY is 3.4 cm (New), the previous test is 2.3 cm
- The new and previous LAL calculated by transmittance are 6.1728 cm (New) and 3.0769 cm in the wavelength of 400 nm
- LAL calculated by light intensity is 6.6225 cm (New)

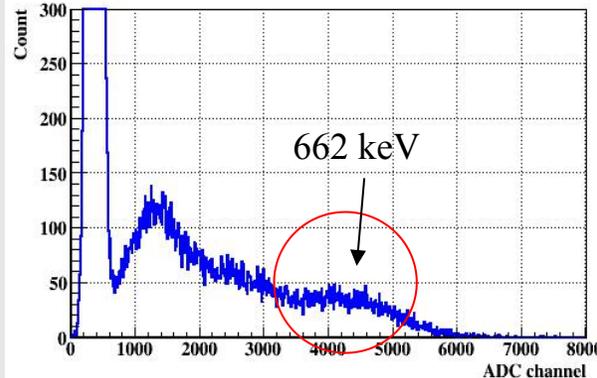
Current status of the GS-HCAL SiPM+GS



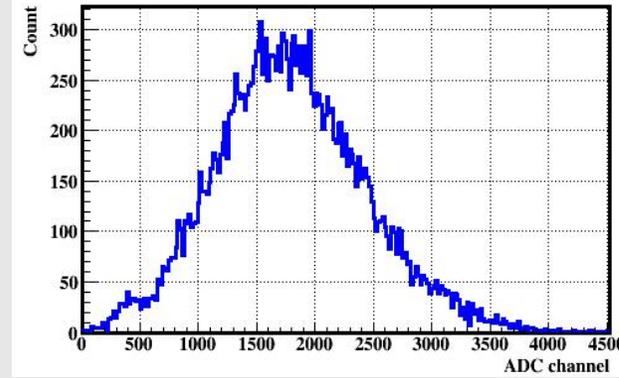
GS: 5mm*5mm*5mm
SiPM: 6 mm*6mm

1. HPK 13360S-6025CS 6 × 6 mm², PDE@400 nm=23%

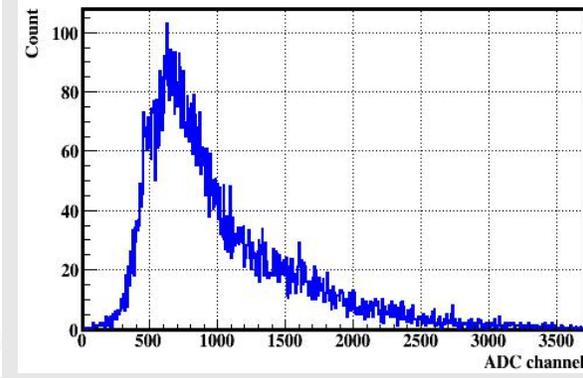
2. HPK 13360S-3025CS 3 × 3 mm², PDE@400 nm=23%



GS: 5mm*5mm*5mm
SiPM: 3 mm*3mm



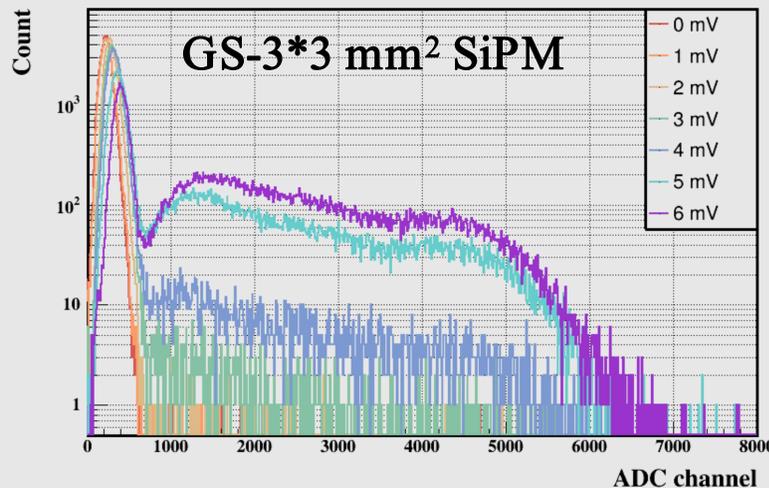
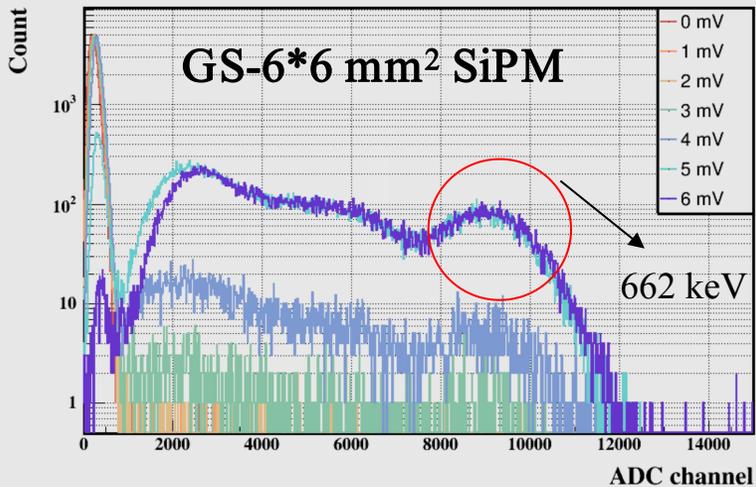
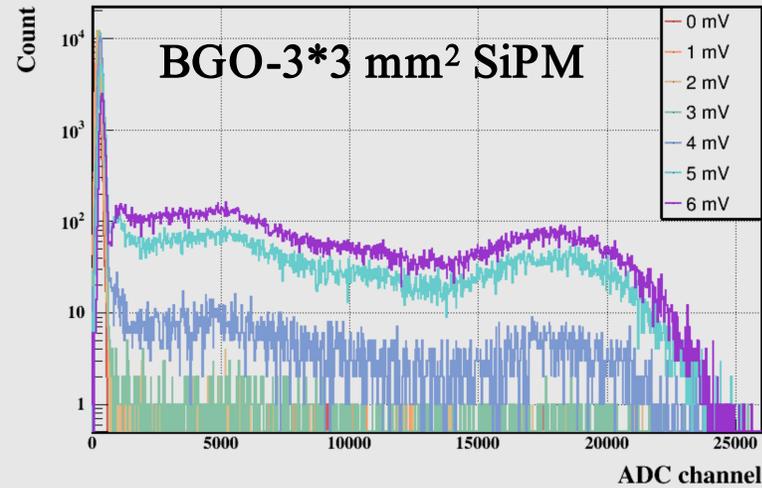
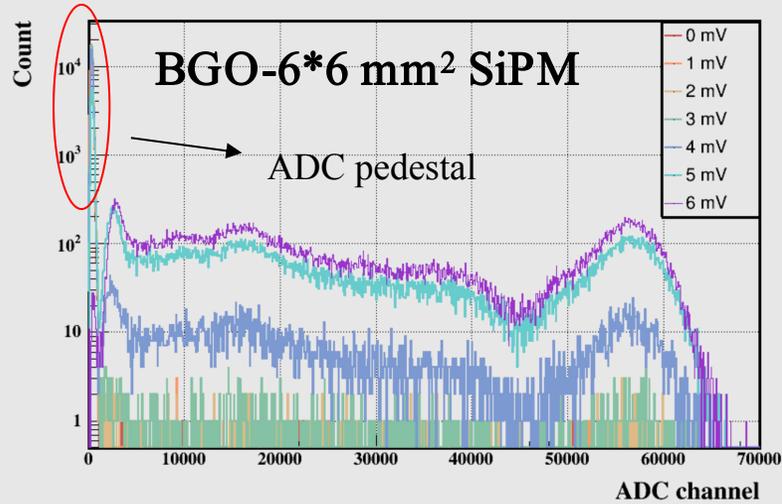
GS: 40mm*40mm*10mm
SiPM: 6 mm*6mm



GS: 40mm*40mm*10mm
SiPM: 3 mm*3mm

SiPM coupled glass	LY (ph/MeV)
Single 3 × 3 mm	51
Single 6 × 6 mm	190
PMT test (2inch-XP2020)	922

Current status of the GS-HCAL SiPM+GS



Experimental conditions

- Scintillator: BGO, GS
- Dimension: 5*5*5 mm³
- Detector:
 1. HPK 13360S-6025CS
6 × 6 mm², PDE@400 nm=23%
 2. HPK 13360S-3025CS
3 × 3 mm², PDE@400 nm=23%

DAQ: DT5751

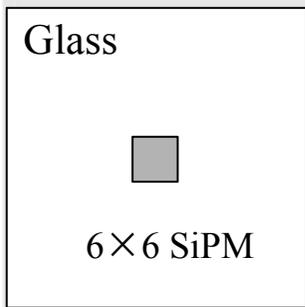
Integral gate: 1000 ns

Coupling: Silicone grease

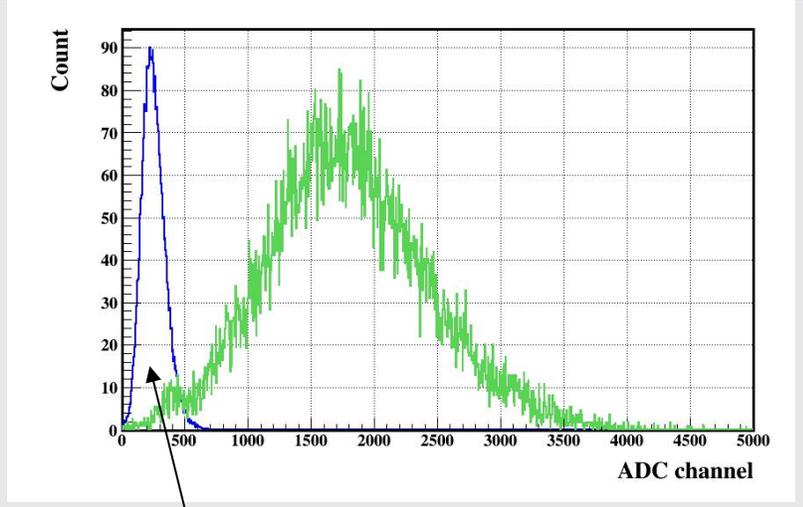
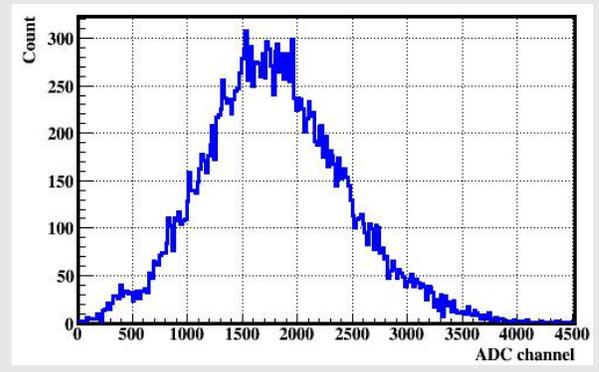
Reflector: Teflon

Source: ¹³⁷Cs

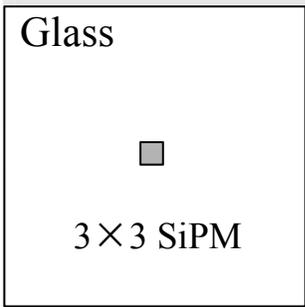
- The influence of threshold setting on energy spectrum testing was investigated
- With increase of the threshold, count rate of noise decreases and scintillation signal increases
- Excluding the pedestal, the light yield of BGO is 7919 ph/MeV (11.7%@662keV), and that of GS is 1331 ph/MeV (24.7%@662keV).



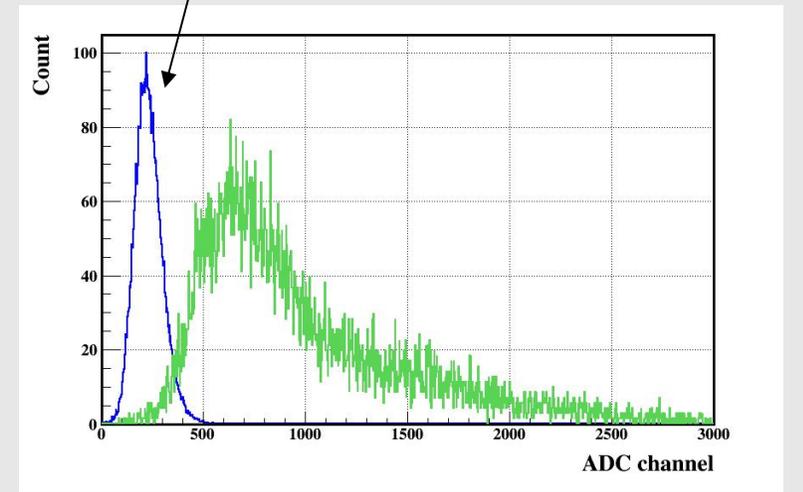
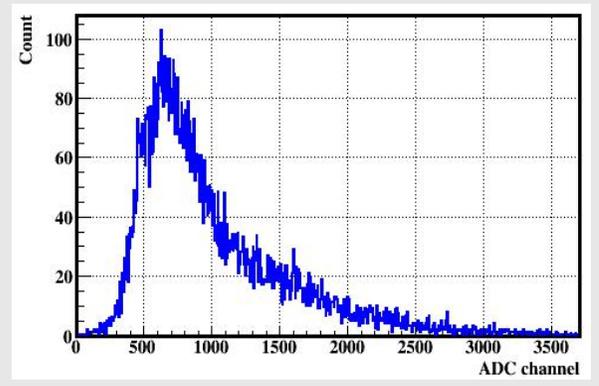
GS: 40mm*40mm*10mm
SiPM: 6 mm*6mm



Electronic pedestal



GS: 40mm*40mm*10mm
SiPM: 3 mm*3mm



Current status of the GS-HCAL Simulation

- Two Post Doctors of SJTU join us for the simulation work with Guo Fangyi and Li Henne

Overview



上海交通大学
SHANGHAI JIAO TONG UNIVERSITY

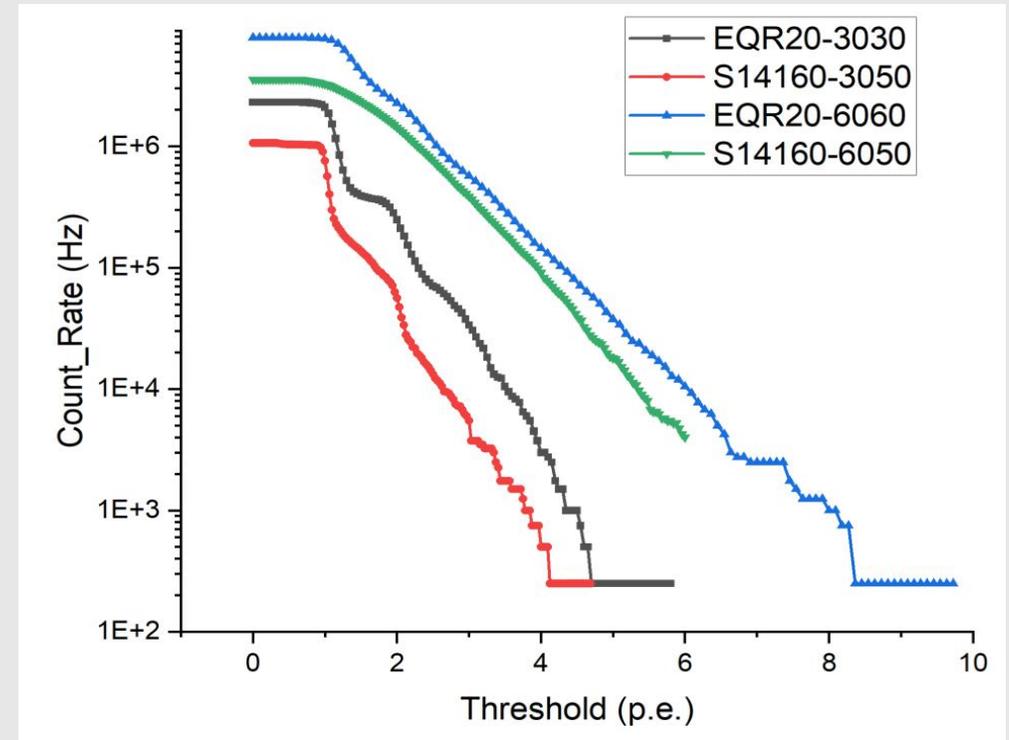
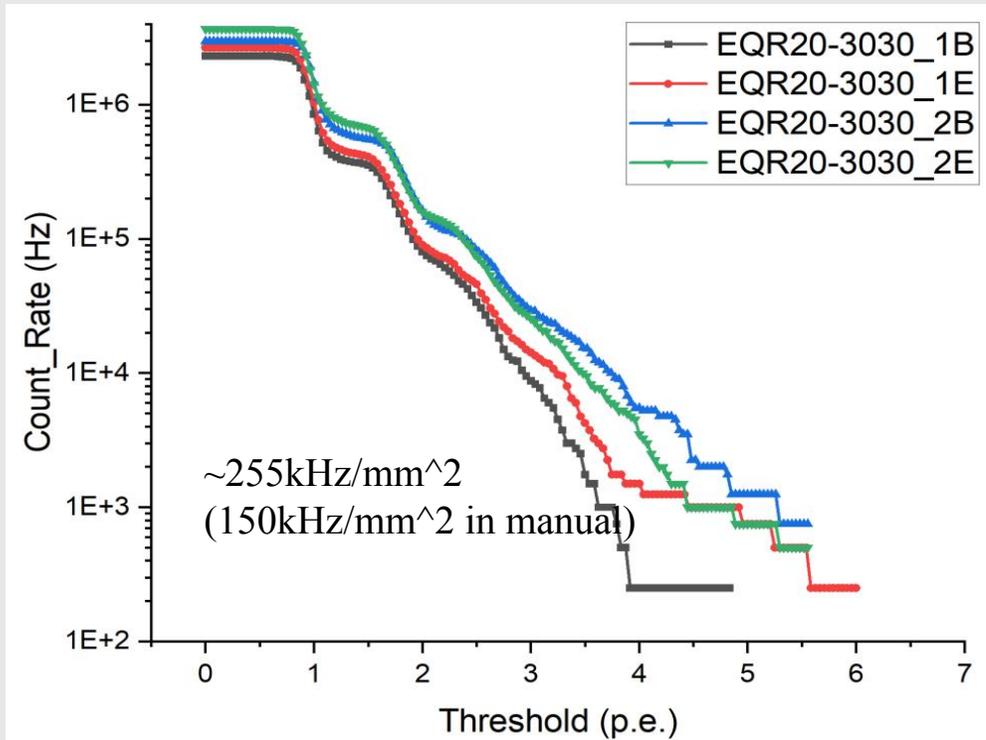
李政道研究所
Tsung-Dao Lee Institute

- Starting from Fangyi's instruction
- Short term task:
 - 4 SiPM -> 1 SiPM
 - **Scan attenuation length**
 - {40, 60, 80} x {6*6, 3*3} need map -> 6 sets
 - With a higher light yield
 - -> 50 ~ 200 {50, 80, 100, 150, 200}
 - With Latt {20, 30, 45, 50, 55}, 6*6
 - SiPM
 - 6*6 -> 3*3
 - PDE Raise to 60%
- Current sets:
 - Geometry: HCAL only
 - Birks: 0.01
 - Light yield: **80** p.e./MIP
 - Threshold: 0.1 MIP -> **8P.E/LY**
 - Attenuation length: **23** mm
 - SiPM readout scheme: 1 SiPM. 6025PE
 - ADC saturation: 8192 channel, 3 gain modes.

Current status of the GS-HCAL SiPM

DCR

- 1) 1 p.e. \cong 3mV
- 2) NDL SiPMs (3*3) DCR is not so consistent. HPK has lower DCR (50% of NDL) .
- 3) For 5 p.e. threshold, NDL DCR is ~ 28 Hz/mm², and HPK DCR is ~ 12 Hz/mm².



Current status of the GS-HCAL SiPM

➤ SiPM radiation resistance test (supported by FuDan)

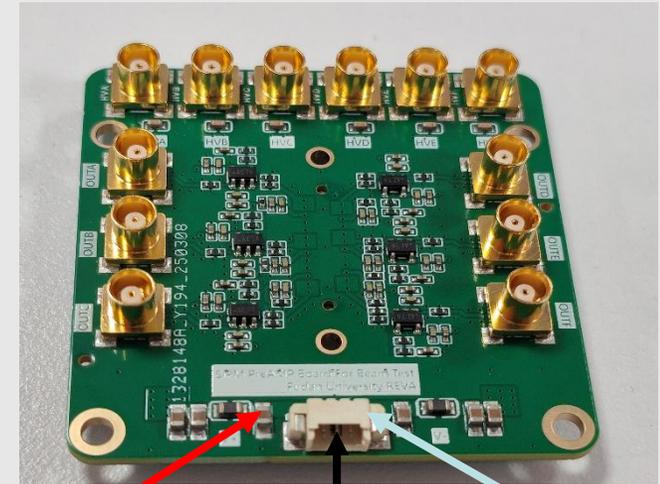
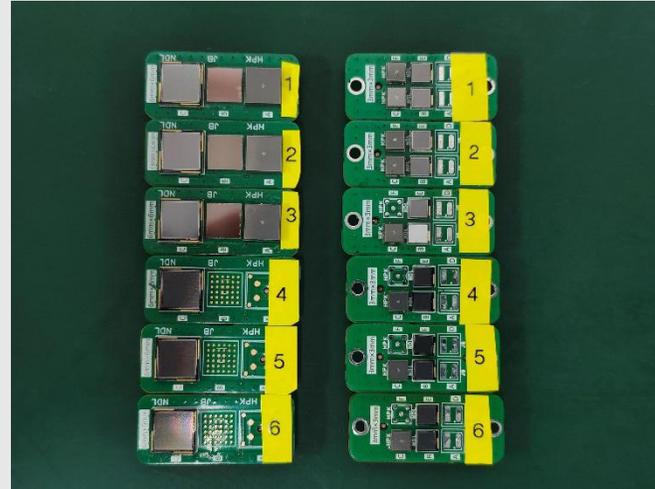
1). Test PCB and SiPM samples

ready, HPK, NDL and JBT,

- ① 3*3(18pcs) mm² SiPMs.
- ② 6*6 (12pcs) mm² SiPMs.

2). Compare:

I/V curve, Id, DCR, relative gain, etc.

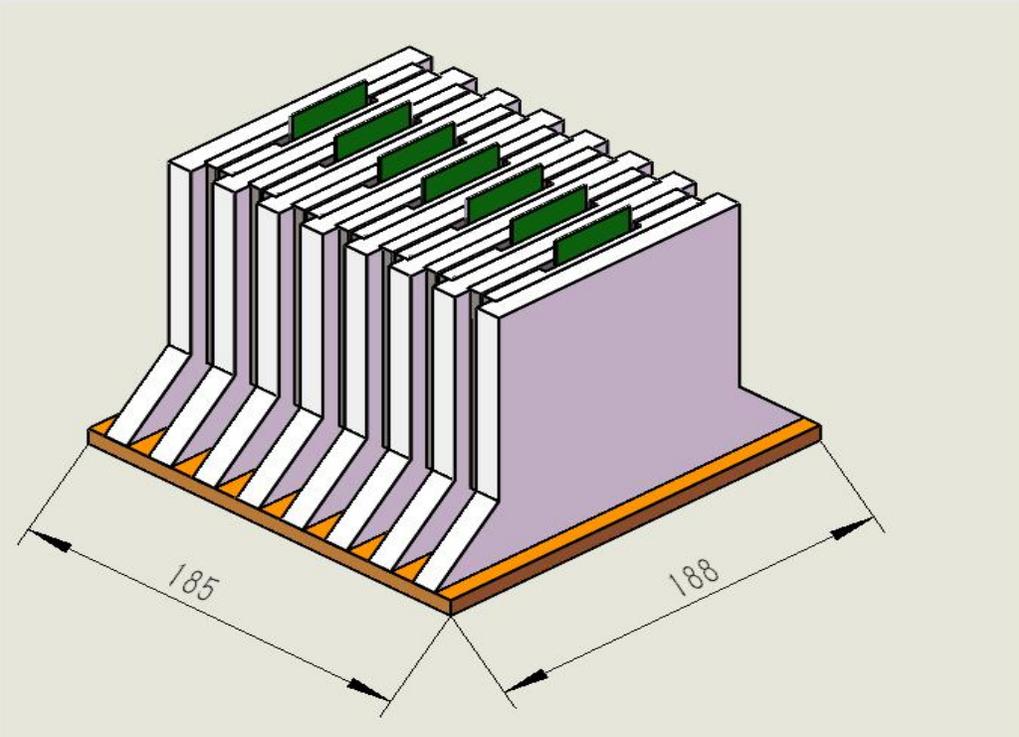
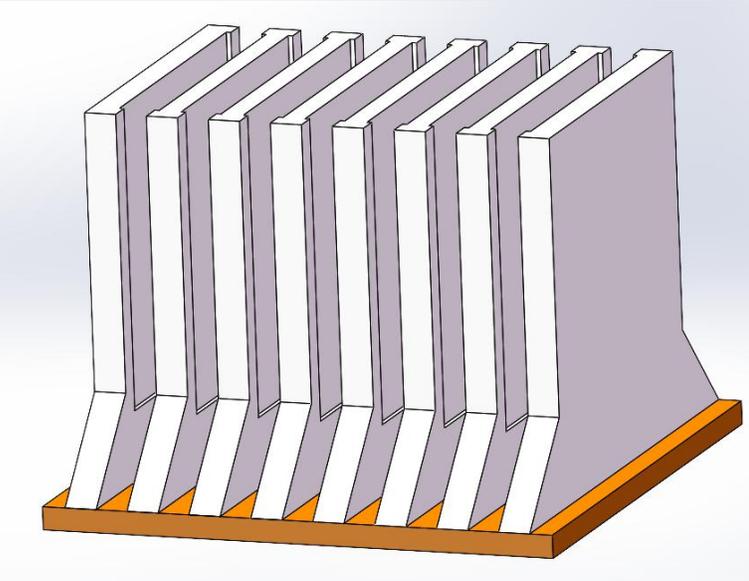
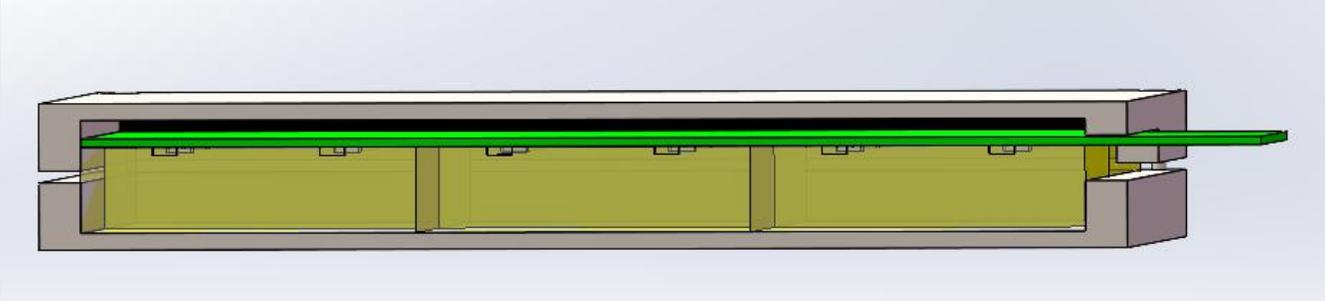
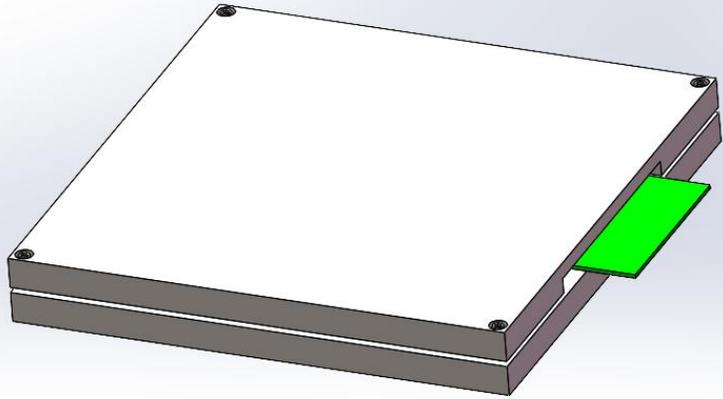


+2.5V(VCC) GND -2.5V(VEE)

Item			NDL	HPK	JBT
1	SiPM	3*3	2*6 = 12 (EQR20 11-3030D-S)	1*6 = 6 (S14160-3050HS)	0 (RQL3035QFN)
2	SiPM	6*6	1*6 = 6 (EQR20 11-6060D-S)	1*3 = 3 (S14160-6050HS)	1*3 = 3 (JSP-TP6050-SMT)
3	base(PCB)		2 SiPM/PCB	2 SiPM/PCB	2 SiPM/PCB
4	FEB+SiPM		3 sets (4-3*3 SIPM)	3 sets-(4-6*6 SIPM)	-
Compare: I/V, Id, DCR, rGain(50%), etc.					



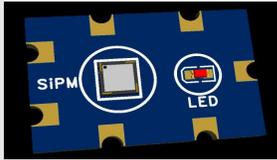
Current status of the GS-HCAL Mini-Prototype



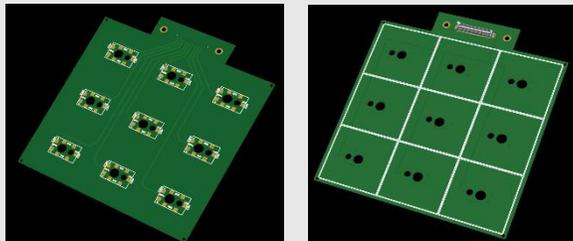
Current status of the GS-HCAL Mini-Prototype

Mini-prototype consideration

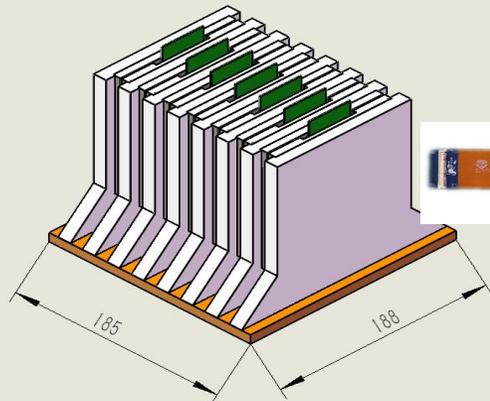
One $3 \times 3 \text{mm}^2$ SiPM + 1 LED/Cell



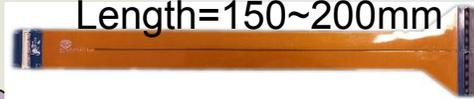
$3 \times 3 = 9$ cells / layer. Prepare both W&O preamp



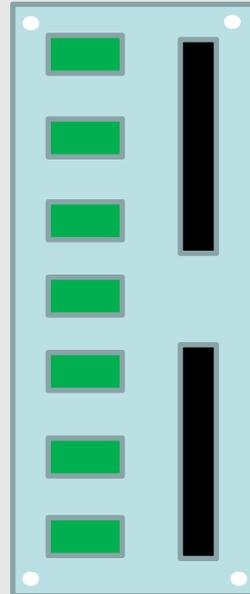
7 layers for Mini-Prototype (63chs)



Flexible cable? X7
($9 \times 7 = 63 \text{chs}$)
Length = 150~200mm



Adapter board
7 in 2 out
What connectors?



What cable? X2
($32 \times 2 = 64 \text{chs}$)
Length = 200~300mm?

Consider:
Grounding
Shielding
Support (As whole module, green frame)



DT5202

Ext triggering



Backup

The Manpower of the HCAL

- 1. The PS-HCAL
 - Jianbei Liu, Haijun Yang, Boxiang Yu, Yunlong Zhang,
- 2. The GS-HCAL : Sen Qian (IHEP)
 - Sub-system: 2 Conveners + others
 - Physics: Manqi Ruan(IHEP), Haijun Yang(SJU),
 - Software: Sengsen Sun(IHEP);
 - Design: Fangyi Guo(IHEP), Hengne Li(SCNU),
 - Glass Scintillator: Sen Qian(IHEP), Jing Ren(HEU), the GS collaboration Group
 - SiPM: Yuguang Xie(IHEP), Jifeng Han(SCU),
 - Electronics: Jingfan Chang(IHEP),
 - DAQ: Chen Boping(IHEP),
 - Mechanics: Yatian Pei(IHEP), Junsong Zhang
 - Detector: Boxiang Yu(IHEP), Yunlong Zhang (USTC),

The Manpower of the subsystem of GSHCAL

Physics: Manqi Ruan(IHEP), Haijun Yang (SJTU) ,

Software: Sengsen Sun(IHEP);

Design: Fangyi Guo(IHEP), Hengne Li(SCNU), Qingming Zhang(XJTU), Weizheng Song(IHEP), Peng Hu(261)
Dejing Du(IHEP), Hongbing Diao(SUTC), Jiyuan Chen(SJTU),

--to design the GS-HCAL detector based on the CEPCSW;

Glass Scintillator: Sen Qian(IHEP), Jing Ren(HEU), the GS collaboration Group;

--R&D of the GS for CEPC-HCAL, a special group independent of CEPC;

SiPM: Yuguang Xie(IHEP), Jifeng Han(SCU), Guang Luo(SYSU),

--to do the research of SiPM for CEPC-HCAL, the electronics of SiPM for the GS performance test;

Electronics: Jingfan Chang(IHEP),

--to design the ASIC and FEE for CEPC-HCAL; the power supply, the cables and so on;

DAQ: Chen Boping(IHEP),

Mechanics: Yatian Pei(IHEP), Junsong Zhang(IHEP), Shang Bofeng(ZZU)

--to design the Mechanics of the GS-CEPC-HCAL; also the cell, the module, the cooling system;

Detector: Boxiang Yu(IHEP), Yunlong Zhang (USTC)

--to study the module of the GS-HCAL with GS and SiPM, the cosmic ray test, the beam test;